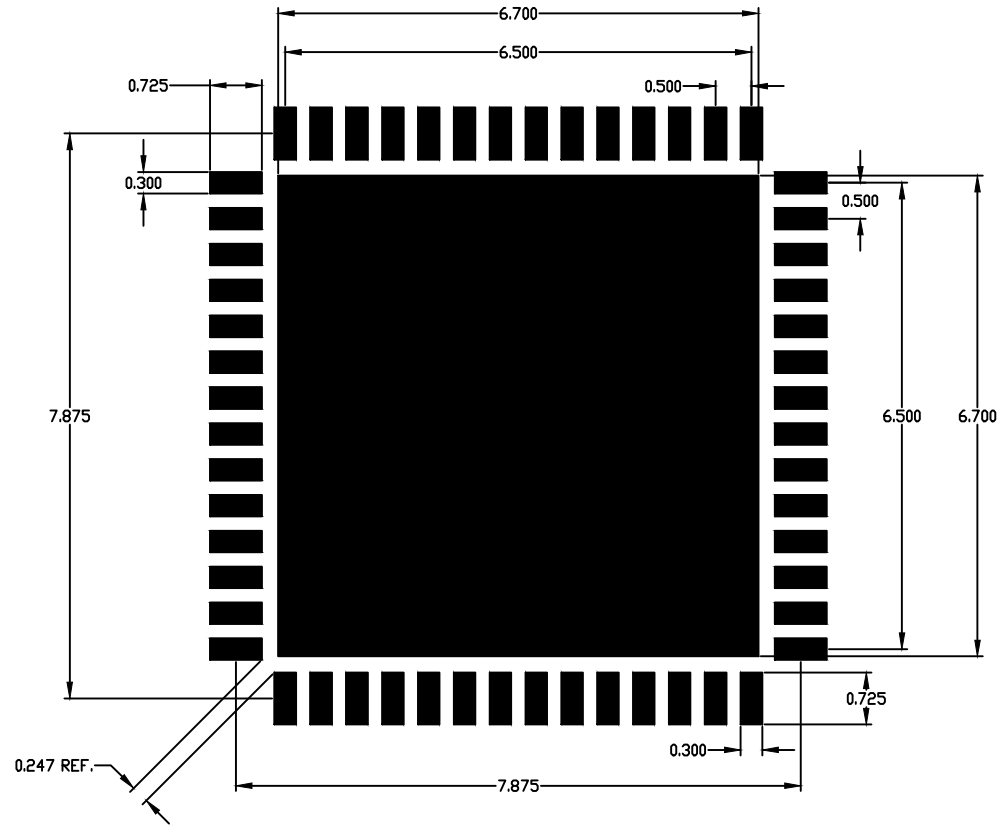


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DOCUMENT TITLE: PACKAGE LAND PATTERN, 8X8 TQFN PKG
EFFECTIVE DATE: 07/07/2022
EXPIRATION DATE:
CHANGE NUMBER: 1166955
ORIGINATOR: Bernard Go

REASON FOR CHANGE:
Add T5688+5C

RECOMMENDED LAND PATTERN

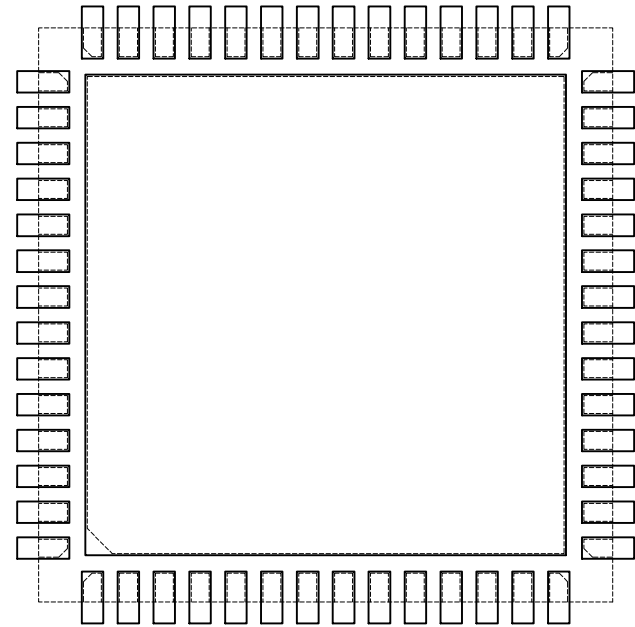


NOTES:

1. REFERENCE PKG. OUTLINE: 21-0135
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. TOLERANCE: +/- 0.02 MM.
4. ALL DIMENSIONS APPLY TO LEADED, PbFREE PACKAGES.
5. ALL DIMENSIONS IN MM.

-DRAWING NOT TO SCALE-

PACKAGE OVERLAY



PKG. CODES
[T5688+2]
[T5688+2C]
[T5688MK+2]
[T5688+5]
[T5688+5C]



This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Analog Devices Inc. (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice. Contact technical support at <http://www.maxim-ic.com/support> for further questions.

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